TD5(3)USPCAN Series

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Isolated UART/SPI T to CAN Module



FEATURES

- Built-in high efficiency isolated power supply
- Two-port isolation test voltage (3kVDC)
- UART baud rate up to 921.6kbps
- SPI rate up to 1.5Mbps
- CAN baud rate up to 1Mbps
- Supporting transparent conversion, transparent tape identification conversion, custom protocol conversion
- Supports two-way data communication between UART/SPI and CAN interface
- Operating ambient temperature range: 40 $^\circ C$ to + 85 $^\circ C$
- The bus supports maximum 110 nodes
- Set isolation and ESD bus protection in one

The main function of TD5(3)USPCAN series is to convert UART/SPI signal into CAN bus differential level to realize signal interface expansion and isolation. TD5(3)USPCAN is a communication conversion module that integrates microprocessor, CAN transceiver, power isolation and signal isolation.

The product is compatible with UART/SPI interface, can be directly embedded into the device with UART/SPI interface, and expands more CAN communication interface on UART/SPI device to realize data communication between UART/SPI device and CAN bus network.

Selection Guide								
Certification	Part No.	Power input (VDC)	Static Current (mA) (Max.)	Maximum Operating Current (mA)	UART Baud rate (bps)	SPI Rate (Mbps)	Can Baud rate (bps)	Number of Nodes
	TD3USPCAN	3.3	40	110	300 - 921600	0 - 1.5	5k - 1M	110
EN	TD5USPCAN	5	40	105	300 - 921600	0 - 1.5	5k - 1M	110

Absolute Limits					
Item Operating Conditions		Min.	Тур.	Max.	Unit
Supply Voltage	3.3V series			3.6	VDC
Supply Voltage	5.0V series			5.5	VDC
Pin Soldering Temperature	Soldering spot is 1.5mm away from case for 10 seconds			300	°C

Input Specifications						
Item		Symbol	Min.	Тур.	Max.	Unit
TD3USPCAN Power Su	upply Input Voltage		3.15	3.3	3.45	
TD5USPCAN Power Supply Input Voltage		VCC	4.75	5.0	5.25	
	High-level	Voh	2.75			VDC
TXD Logic Level	Low-level	Vol			0.4	
RXD Logic Level	High-level	VIH	2.31		5	
	Low-level	Vil	0		0.99	
Serial Interface		Sto	andard UART in	terface		

Time Specifications ⁽¹⁾						
Item	Symbol	Min.	Тур.	Max.	Unit	
Reset Low Hold Time	t _{RST_HOLD}	100	-	-	US	
Initialization Wait Time	t _{INIT_WAIT}	3	-	-	ms	
UART Frame Interval ⁽²⁾	tfram_inter_uart	10*n / fclk_uart	-	-	S	

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Protocol Conversion Module

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SPI Frame Interval		40	-	-	us
SPI State Switching Operation Delay		50	-	-	us
State Hold Time after SPI Write Operation		5	-	-	us
Read Configuration		150	-	-	
Read Configuration	tcfg_wait	3	_	_	ms
Verify Product Identification		3	_	_	
	g Operation Delay fter SPI Write Operation Read Configuration Read Configuration	g Operation Delay tswitch_war fter SPI Write Operation twrite_Hold Read Configuration tcre_war	g Operation Delay tswitch_wait 50 fter SPI Write Operation twrite_Hold 5 Read Configuration 150 Read Configuration tcrg_wait 3	g Operation Delay tswitch_wait 50 - fter SPI Write Operation twrite_Houb 5 - Read Configuration tcre_wait 3 -	g Operation Delay tswitch_wait 50 - fter SPI Write Operation twrite_Houb 5 - Read Configuration tcre_wait 3 -

(2) n is the number of UART frame interval characters actually configured by the user.

Output Spe	cifications					
ltem		Symbol	Min.	Тур.	Max.	Unit
Dominant Level	CANH	V(OD)CANH	2.75	3.5	4.5	
(Logic 0)	CANL	V(OD)CANL	0.5	1.5	2	
Recessive Level	CANH	V(OR)CANH	2	2.5	3	VDC
(Logic 1)	CANL	V(OR)CANL	2	2.5	3	
Differential Level	Dominant Level (Logic 0)	Vdiff(d)	1.5	2	3	
Differential Level	Recessive Level (Logic 1)	Vdiff(r)	-0.05	0	0.05	
Bus Pin Maximum	Withstand Voltage	Vx	-36		+36	
Load Resistance Differential		RL	45	60	65	Ω
Input Impedance Differential		Raiff	40		100	kΩ
CAN Bus Interface	ð	Meets ISO/DIS 11898-2 standard Twisted-pair output				

General Specifications				
Item	Operating Conditions	Value		
Isolation Test	Electric strength test for 1 min., leakage current <1mA	3 KVDC		
Insulation Resistance	At 500VDC	1000M Ω (CAN bus - others)		
Operating Temperature		- 40℃ to + 85℃		
Transportation and Storage Temperature		- 50℃ to + 105℃		
Operating Humidity	Non-condensing	10% - 90%		
Safety Standard		EN62368-1 (Report)		

Mechanical Specifications		
Case Material	WH9100-F (UL94 V-0)	
Package	DIP24	
Weight	11.4g(Typ.)	
Cooling Method	Free air convection	

Electro	Electromagnetic Compatibility (EMC)				
	ESD	IEC/EN 61000-4-2 Contact±2kV/ Air±4kV	Perf. Criteria B		
las as us in (EFT	IEC/EN 61000-4-4 ±2kV	Perf. Criteria B		
Immunity	Surge	IEC/EN 61000-4-5 ±2kV(line to ground)	Perf. Criteria B		
CS IEC/EN 61000-4-6 3Vr.m.s Perf. Criteria A					
Note: Only for the CAN communication port, CANH, CANL or CGND, the CAN bus port is left floating during the test.					

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Protocol Conversion Module

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Working Sequence Diagram



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Application Precautions

- 1. Carefully read and follow the instructions before use; contact our technical support if you have any question;
- 2. Do not use the product in hazardous areas;
- 3. Use only DC power supply source for this product. 220V AC power supply is prohibited;
- 4. It is strictly forbidden to disassemble the product privately in order to avoid product failure or malfunction.
- 5. Hot-swap is not supported.

After-sales service

- 1. Factory inspection and quality control are strictly enforced before shipping any product; please contact your local representative or our technical support if you experience any abnormal operation or possible failure of the module;
- 2. The products have a 3-year warranty period, from the date of shipment. The product will be repaired or exchanged free of charge within the warranty period for any quality problem that occurs under normal use.

Design Reference

1. SPI to CAN hardware circuit

When using the SPI to CAN function, the MODE pin needs to be tied high. The SPI interface of the MCU is connected to the SPI interface of the TD5(3)USPCAN. At the same time, the MCU needs to provide GPIO connection with RST, INT, CTLO and CTL1 pins to realize effective monitoring and control of TD5(3)USPCAN. If the TD5(3)USPCAN needs to be configured through the MCU, an additional GPIO is required to connect to the CFG pin. Figure 6 and Figure 7 are the reference circuits of TD3USPCAN and TD5USPCAN, respectively.



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2. UART to CAN hardware circuit

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When using the UART to CAN function, the MODE pin needs to be tied low. The UART of the MCU is connected to the UART interface of the TD5(3)USPCAN, and a GPIO is connected to the RST pin. If the TD5(3)USPCAN needs to be configured through the MCU, an additional GPIO is required to be connected to the CFG pin. Figure 8 and Figure 9 are the reference circuits of TD3USPCAN and TD5USPCAN, respectively.











Note: Ground shield of twisted wire pair reliably. Recommended components and values:

Component	Recommended part, value	Component	Recommended part, value
R3	1 Μ Ω	R1、R2	2.7 Ω /2W
C1	1nF, 2kV	D1、D2	1N4007
T1	ACM2520-301-2P	D3	SMBJ30CA
GDT	B3D090L	TVS1	SMBJ5.0A(TD3USPCAN)/SMBJ6.5A (TD5USPCAN)
C2	10uF,25V	Rterminal	120 Ω

When the module is used in applications with harsh environment, it can be susceptible to large energy like lightning strike, etc. in which case, it is essential to add an adequate protection circuit to the CAN signal ports to protect the system from failure and maintain a reliable bus communication. Figure 10 provides a recommended protection circuit design for high-energy lightning surges, with a degree of protection related to the selected protection device. Parameter description lists a set of recommended circuit parameters, which can be adjusted according to the actual application situation. Also, when using the shielded cable, the reliable single-point grounding of the shield must be achieved.

Note: The recommended components that will change the Specifications of Bus Pin Maximum Withstand Voltage by D3 and its values is a general guideline only. It must be verified for the actual user's application. We recommended using PTC's for R1 and R2 and to use fast recovery diodes for D1 and D2.



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4. Recommended networking mode

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The CAN bus generally uses a linear wiring method. The maximum number of nodes per network is 110, the longest communication distance of the universal module is 10km, and the high-speed support minimum baud rate is 5kbps. Figure 11 is a schematic diagram of the recommended networking.

Note: The communication distance of the bus is related to the communication speed and its field application. It can be designed according to the actual application and reference standard. We recommended the use of a twisted pair or shielded twisted pair as the communication cable and it should be kept away from any sources of interference. For long-distance communication, the terminal resistance value needs to be selected in accordance with the communication distance, the cable impedance and the number of nodes.



Fig.11

5. Precautions

- 1) TD5USPCAN and TD3USPCAN are for 3.3V TTL level only (not compatible with 5V).
- 6. For additional information, please refer to our application note on www.mornsun-power.com



Dimensions and Recommended Layout



THIRD ANGLE PROJECTION



Note: Unit: mm[inch] Pin diameter tolerances: $\pm 0.10[\pm 0.004]$ General tolerances: $\pm 0.50[\pm 0.020]$



Pin-Out					
Pin	Mark	Function			
1	VCC	Input Power+			
2	GND	GND			
3	RST	Reset Pin			
4	TXD	UART Send Pin			
5	RXD	UART Receive Pin			
6	MODE	Mode Control Pin			
7	CTL1	SPI Master Control Pin 1			
10	CGND	Isolated Power Output CGND			
11	CANL	CANL Pin			
12	CANH	CANH Pin			
18	SSEL	SPI Chip Select Pin			
19	CTL0	SPI Master Control Pin 0			
20	INT	Slave Feedback Pin			
21	SCK	SPI SCK Pin			
22	MOSI	SPI MOSI Pin			
23	MISO	SPI MISO Pin			
24	CFG	Configuration Pin			

Notes:

- 1. For additional information on Product Packaging please refer to <u>www.mornsun-power.com</u>. The Packaging bag number: 58210008;
- 2. Unless otherwise specified, parameters in this datasheet were measured under the conditions of Ta=25°C, humidity<75%RH with nominal input voltage and rated output load;
- 3. All index testing methods in this datasheet are based on company corporate standards;
- 4. The above are the performance indicators of the product models listed in this datasheet. Some indicators of non-standard models will exceed the above requirements. For details, please contact our technical staff;
- 5. We can provide product customization service, please contact our technicians directly for specific information;
- 6. Products are related to laws and regulations: see "Features" and "EMC";
- 7. Our products shall be classified according to ISO14001 and related environmental laws and regulations, and shall be handled by qualified units.

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